December 2007

74VHCT04A Hex Inverter

Features

- High speed: $t_{PD} = 4.7$ ns (Typ.) at $T_A = 25$ °C
- High noise immunity: $V_{IH} = 2.0V$, $V_{IL} = 0.8V$
- Power down protection is provided on all inputs and outputs
- Low noise: V_{OLP} = 1.0V (Max.)
- Low power dissipation: $I_{CC} = 2\mu A$ (Max.) @ $T_A = 25$ °C
- Pin and function compatible with 74HCT04

General Description

The VHCT04A is an advanced high speed CMOS Inverter fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

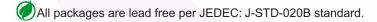
The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

Protection circuits ensure that 0V to 7V can be applied to the input pins without regard to the supply voltage and to the output pins with $V_{CC}=0V$. These circuits prevent device destruction due to mismatched supply and input/output voltages. This device can be used to interface 3V to 5V systems and two supply systems such as battery backup.

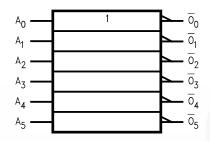
Ordering Information

Order Number	Package Number	Package Description
74VHCT04AM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHCT04ASJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHCT04AMTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.



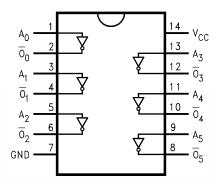
Logic Symbol



Pin Description

Pin Names	Description
A _n	Inputs
\overline{O}_n	Outputs

Connection Diagram



Truth Table

Α	ō
L	Н
Н	L

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +7.0V
V _{IN}	DC Input Voltage	-0.5V to +7.0V
V _{OUT}	DC Output Voltage	
	Note 1	-0.5V to V _{CC} + 0.5V
	Note 2	-0.5V to 7.0V
I _{IK}	Input Diode Current	–20mA
I _{OK}	Output Diode Current ⁽³⁾	±20mA
I _{OUT}	DC Output Current	±25mA
I _{cc}	DC V _{CC} /GND Current	±50mA
T _{STG}	Storage Temperature	−65°C to +150°C
TL	Lead Temperature (Soldering, 10 seconds)	260°C

Recommended Operating Conditions⁽⁴⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating		
V _{CC}	Supply Voltage	4.5V to +5.5V		
V _{IN}	Input Voltage	0V to +5.5V		
V _{OUT}	Output Voltage			
	Note 2	0V to V _{CC}		
	Note 3	0V to 5.5V		
T _{OPR}	Operating Temperature			
t _r , t _f	Input Rise and Fall Time, V _{CC} = 5.0V ±0.5V	0ns/V ~ 20ns/V		

Notes:

- 1. HIGH or LOW state. I_{OUT} absolute maximum rating must be observed.
- 2. $V_{CC} = 0V$.
- 3. $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ (Outputs Active).
- 4. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

					Т	' _A = 25°	С		–40°C 85°C	
Symbol	Parameter	V _{CC} (V)	Con	ditions	Min.	Тур.	Max.	Min.	Max.	Units
V _{IH}	HIGH Level Input	4.5			2.0			2.0		V
	Voltage	5.5			2.0			2.0]
V _{IL}	LOW Level Input	4.5					0.8		0.8	V
	Voltage	5.5					0.8		0.8]
V _{OH}	HIGH Level Output	4.5	$V_{IN} = V_{IH}$	$I_{OH} = -50\mu A$	4.40	4.50		4.40		V
	Voltage			$I_{OH} = -8mA$	3.94			3.80]
V _{OL}	LOW Level Output	4.5	$V_{IN} = V_{IH}$	$I_{OL} = 50 \mu A$		0.0	0.1		0.1	V
	Voltage			$I_{OL} = 8mA$			0.36		0.44]
I _{IN}	Input Leakage Current	0 – 5.5	V _{IN} = 5.5V	or GND			±0.1		±1.0	μA
I _{CC}	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND				2.0		20.0	μA
I _{CCT}	Maximum I _{CC} /Input	5.5	V _{IN} = 3.4V, Other Inputs = V _{CC} or GND				1.35		1.50	mA
l _{OFF}	Output Leakage Current (Power Down State)	0.0	V _{OUT} = 5.5	5V			0.5		5.0	μА

Noise Characteristics

				$T_A =$	25°C	
Symbol	Parameter	Conditions	$V_{CC}(V)$	Тур.	Limit	Units
V _{OLP} ⁽⁵⁾	Quiet Output Maximum Dynamic V _{OL}	$C_L = 50pF$	5.0	0.8	1.0	V
V _{OLV} ⁽⁵⁾	Quiet Output Minimum Dynamic V _{OL}	$C_L = 50pF$	5.0	-0.8	1.0	V
V _{IHD} ⁽⁵⁾	Minimum HIGH Level Dynamic Input Voltage	$C_L = 50pF$	5.0		2.0	V
V _{ILD} ⁽⁵⁾	Maximum LOW Level Dynamic Input Voltage	C _L = 50pF	5.0		0.8	V

Note:

5. Parameter guaranteed by design.

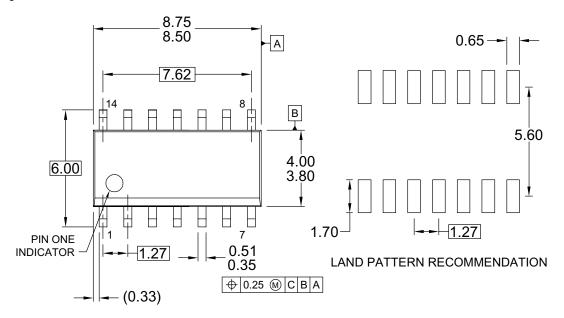
AC Electrical Characteristics

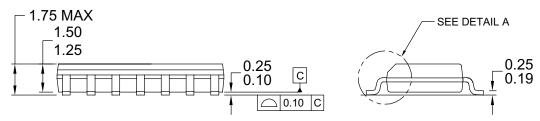
				Т	' _A = 25°	С		-40°C 85°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
t _{PHL} , t _{PLH}	Propagation Delay	5.0 ± 0.5	C _L = 15pF		4.7	6.7	1.0	7.5	ns
			C _L = 50pF		5.5	7.7	1.0	8.5	
C _{IN}	Input Capacitance		V _{CC} = Open		4	10		10	pF
C _{PD}	Power Dissipation Capacitance		(6)		17				pF

Note

C_{PD} is defined as the value of the internal equivalent capacitance, which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation:
 I_{CC} (Opr.) = C_{PD} • V_{CC} • f_{IN} + I_{CC} / 6 (per gate)

Physical Dimensions





NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C,
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X145-14M
- E) DRAWING CONFORMS TO ASME Y14.5M-1994
- F) DRAWING FILE NAME: M14AREV13

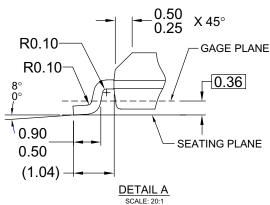


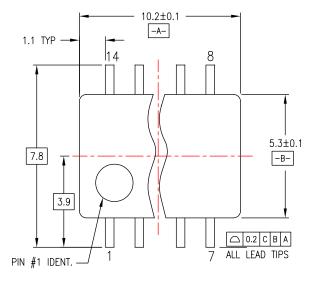
Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

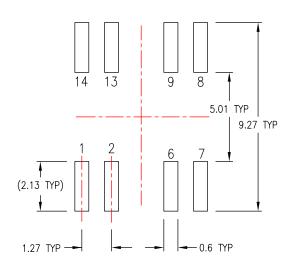
Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

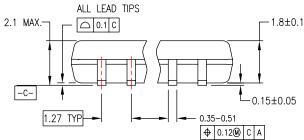
http://www.fairchildsemi.com/packaging/

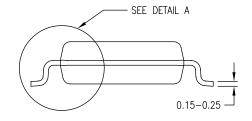
Physical Dimensions (Continued)





LAND PATTERN RECOMMENDATION





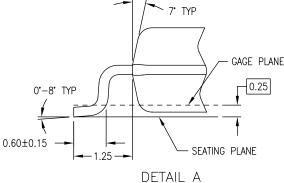
DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

 B. DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD

FLASH, AND TIE BAR EXTRUSIONS.



M14DREVC

Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/

Physical Dimensions (Continued) 5.0±0.1 -A-0.65 0.43 TYP 6.4 4.4±0.1 -B-1.65 3.2 □ 0.2 C B A PIN #1 IDENT. 6.10 0.45 -LAND PATTERN RECOMMENDATION SEE DETAIL A ALL LEAD TIPS 0.90+0.15 1.2 MAX ○ 0.1 C 0.09-0.20 -C-0.10±0.05 0.65 0.19 - 0.30⊕ |0.13\\(\) |A |B\(\) |C\(\) 12.00°TOP & BOTTOM R0.09 min GAGE PLANE 0.25 0°-8° NOTES: 0.6±0.1 A. CONFORMS TO JEDEC REGISTRATION MO-153, SEATING PLANE R0.09min -1 00

- VARIATION AB, REF NOTE 6
- **B. DIMENSIONS ARE IN MILLIMETERS**
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982
- E. LANDPATTERN STANDARD: SOP65P640X110-14M
- F. DRAWING FILE NAME: MTC14REV6

Figure 3. 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/

DETAIL A





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™ CorePLUS™ $CROSSVOLT^{\text{\tiny IM}}$ CTL™

Current Transfer Logic™ EcoSPARK® EZSWITCH™ *

Fairchild[®] Fairchild Semiconductor® FACT Quiet Series™

FACT[®] $\mathsf{FAST}^{\mathbb{R}}$ FastvCore™ FlashWriter® 3 FPS™ $\mathsf{FRFET}^{\scriptscriptstyle{\textcircled{\tiny{\$}}}}$

Global Power Resource[™]

Green FPS™

Green FPS™ e-Series™

GTO™ i-Lo™ IntelliMAX™ ISOPLANAR™ MegaBuck™ MICROCOUPLER™

MicroFET™ MicroPak™ MillerDrive™ Motion-SPM™ OPTOLOGIC®

OPTOPLANAR®

PDP-SPM™ Power220® Power247® POWEREDGE® Power-SPM™ PowerTrench®

Programmable Active Droop™

QFET[©] QSTM

QT Optoelectronics™ Quiet Series™ RapidConfigure™ SMART START™

SPM® STEALTH™ SuperFET™ SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 TinvBuck™ TinyLogic[®] TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ uSerDes™ **UHC**®

Ultra FRFET™ UniFET™ VCX^{TM}

SyncFET™ SYSTEM ®
GENERAL

puwer

franchise

TinyBoost™

The Power Franchise®

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS. NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition				
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.				
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.				
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.				
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.				

Rev. 132

^{*} EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

74VHCT04AN_Q 74VHCT04AMTC_Q 74VHCT04ASJ 74VHCT04AN 74VHCT04ASJ_Q 74VHCT04AMTCX_NL 74VHCT04ASJX_NL